

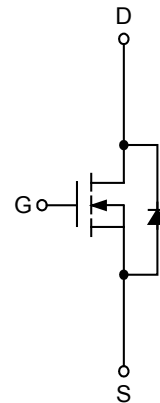
Features

- 60V/69A
 $R_{DS(ON)}=8.6m\Omega(max.)@V_{GS}=10V$
 $R_{DS(ON)}=12m\Omega(max.)@V_{GS}=4.5V$
- 100% UIS + R_g Tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

Pin Description



TO-220




N-Channel MOSFET

Applications

- Secondary Side Synchronous Rectification.
- DC-DC Converter.
- Motor Control.
- Load Switching.

Ordering and Marking Information

| | |
|---|---|
| <p>SM6165NH - </p> (Temperature Range), (Handling Code), and (Assembly Material)." data-bbox="210 580 490 700"/> <p>Assembly Material Handling Code Temperature Range Package Code</p> | <p>Package Code F : TO-220 Operating Junction Temperature Range C : -55 to 150 °C Handling Code TU : Tube Assembly Material G : Halogen and Lead Free Device</p> |
| <p>SM6165NH F :</p> | <div style="border: 1px solid black; padding: 5px; display: inline-block;">  <p>SM6165NH XXXXX</p> </div> <p style="margin-left: 20px;">XXXXX - Lot Code</p> |

Note : SINOPOWER lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. SINOPOWER lead-free products meet or exceed the leadfree requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. SINOPOWER defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

SINOPOWER reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

| Symbol | Parameter | Rating | Unit |
|-----------------------|--|--|-----------------------------|
| Common Ratings | | | |
| V_{DSS} | Drain-Source Voltage | 60 | V |
| V_{GSS} | Gate-Source Voltage | ± 20 | |
| T_J | Maximum Junction Temperature | 150 | $^{\circ}\text{C}$ |
| T_{STG} | Storage Temperature Range | -55 to 150 | |
| I_S | Diode Continuous Forward Current | $T_C=25^{\circ}\text{C}$ 34 | A |
| I_D | Continuous Drain Current | $T_C=25^{\circ}\text{C}$ 69 | A |
| | | $T_C=100^{\circ}\text{C}$ 43 | |
| I_{DM} | Pulsed Drain Current | $T_C=25^{\circ}\text{C}$ 276 ^a | |
| P_D | Maximum Power Dissipation | $T_C=25^{\circ}\text{C}$ 73.5 | W |
| | | $T_C=100^{\circ}\text{C}$ 29.4 | |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case | Steady state 1.7 | $^{\circ}\text{C}/\text{W}$ |
| I_D | Continuous Drain Current | $T_A=25^{\circ}\text{C}$ 11.3 | A |
| | | $T_A=70^{\circ}\text{C}$ 9.1 | |
| P_D | Maximum Power Dissipation | $T_A=25^{\circ}\text{C}$ 2 | W |
| | | $T_A=70^{\circ}\text{C}$ 1.28 | |
| $R_{\theta JA}$ | Thermal Resistance-Junction to Ambient | Steady state 62.5 | $^{\circ}\text{C}/\text{W}$ |
| I_{AS}^b | Avalanche Current, Single pulse | $L=0.5\text{mH}$ 18 | A |
| E_{AS}^b | Avalanche Energy, Single pulse | $L=0.5\text{mH}$ 81 | mJ |

Note a : Pulse width limited by max. junction temperature.

Note b : UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature $T_J=25^{\circ}\text{C}$).

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

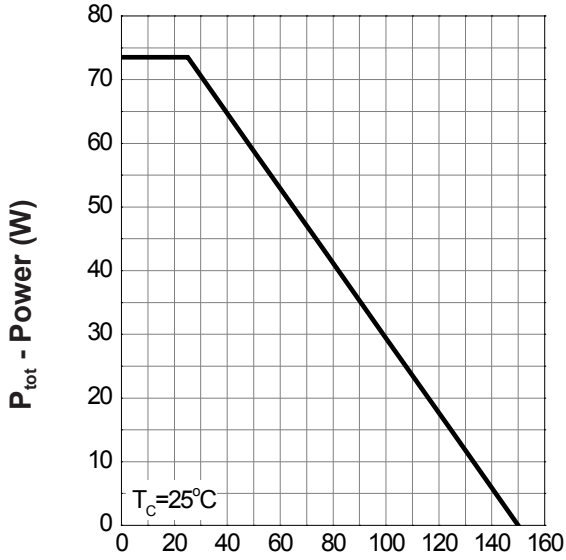
| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--|----------------------------------|---|------|------|-----------|------------|
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_{DS}=250\mu A$ | 60 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=48V, V_{GS}=0V$ | - | - | 1 | μA |
| | | $T_J=85^\circ C$ | - | - | 30 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_{DS}=250\mu A$ | 1 | 2 | 3 | V |
| I_{GSS} | Gate Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| $R_{DS(ON)}^c$ | Drain-Source On-state Resistance | $V_{GS}=10V, I_{DS}=20A$ | - | 7.2 | 8.6 | m Ω |
| | | $V_{GS}=4.5V, I_{DS}=15A$ | - | 9.2 | 12 | |
| Diode Characteristics | | | | | | |
| V_{SD}^c | Diode Forward Voltage | $I_{SD}=20A, V_{GS}=0V$ | - | 0.8 | 1.3 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD}=20A, di_{SD}/dt=100A/\mu s$ | - | 30 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 29 | - | nC |
| Dynamic Characteristics^d | | | | | | |
| R_G | Gate Resistance | $V_{GS}=0V, V_{DS}=0V, F=1MHz$ | - | 1 | - | Ω |
| C_{iss} | Input Capacitance | $V_{GS}=0V,$ $V_{DS}=30V,$ Frequency=1.0MHz | - | 1500 | 1950 | pF |
| C_{oss} | Output Capacitance | | - | 280 | - | |
| C_{rss} | Reverse Transfer Capacitance | | - | 40 | - | |
| $t_{d(ON)}$ | Turn-on Delay Time | $V_{DD}=30V, R_L=30\Omega,$ $I_{DS}=1A, V_{GEN}=10V,$ $R_G=6\Omega$ | - | 9 | 16 | ns |
| t_r | Turn-on Rise Time | | - | 5 | 9 | |
| $t_{d(OFF)}$ | Turn-off Delay Time | | - | 29 | 52 | |
| t_f | Turn-off Fall Time | | - | 30 | 54 | |
| Gate Charge Characteristics^d | | | | | | |
| Q_g | Total Gate Charge | $V_{DS}=30V, V_{GS}=4.5V,$ $I_{DS}=20A$ | - | 11.7 | - | nC |
| Q_g | Total Gate Charge | $V_{DS}=30V, V_{GS}=10V,$ $I_{DS}=20A$ | - | 25 | 35 | |
| Q_{gs} | Gate-Source Charge | | - | 5.1 | - | |
| Q_{gd} | Gate-Drain Charge | | - | 3.8 | - | |

Note c : Pulse test ; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

Note d : Guaranteed by design, not subject to production testing.

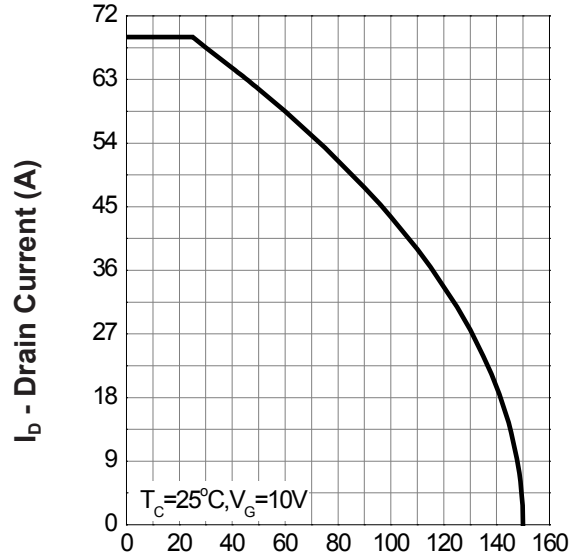
Typical Operating Characteristics

Power Dissipation



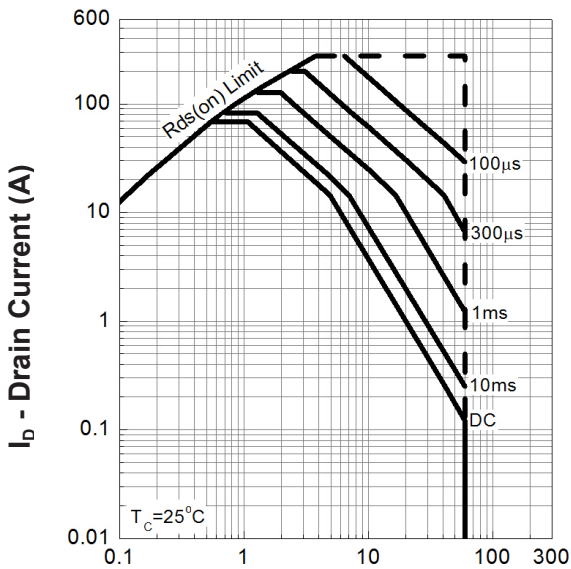
T_j - Junction Temperature ($^{\circ}\text{C}$)

Drain Current



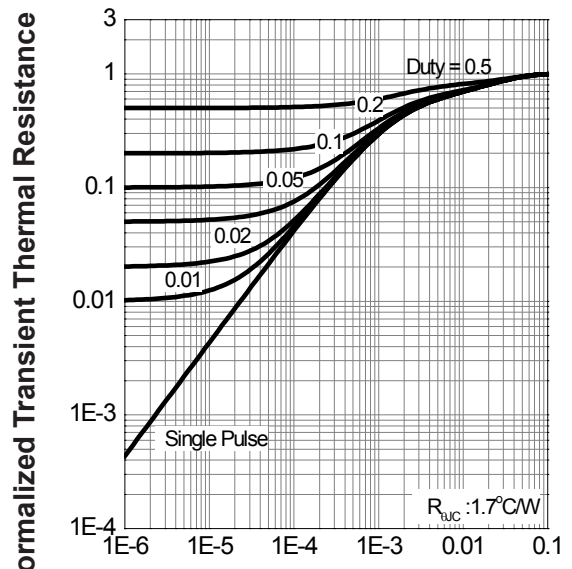
T_j - Junction Temperature ($^{\circ}\text{C}$)

Safe Operation Area



V_{DS} - Drain - Source Voltage (V)

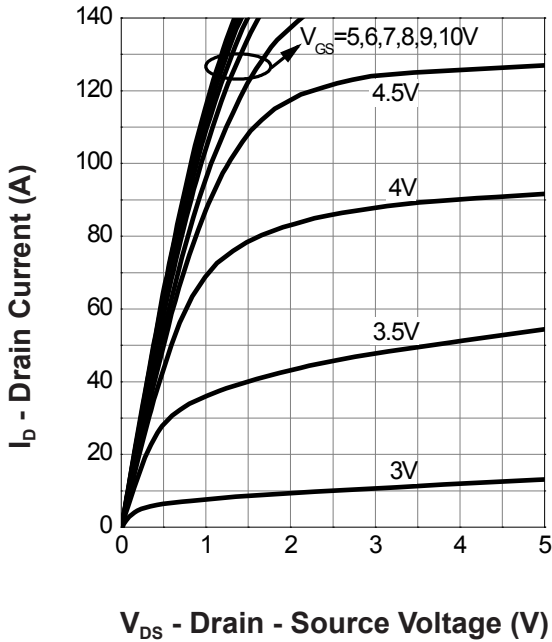
Thermal Transient Impedance



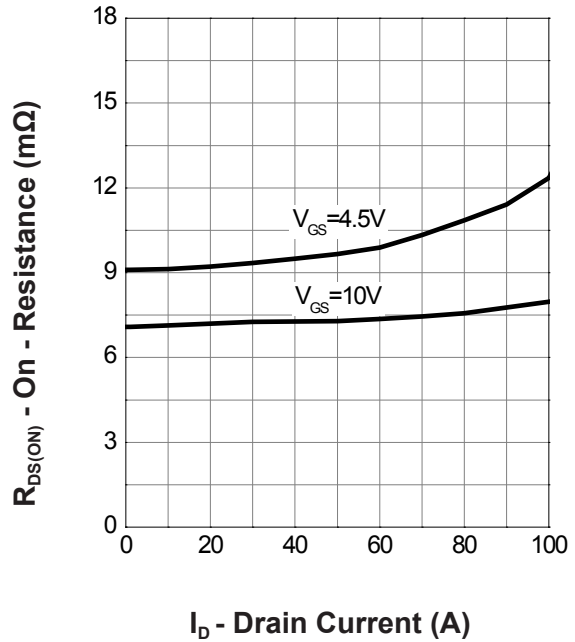
Square Wave Pulse Duration (sec)

Typical Operating Characteristics(Cont.)

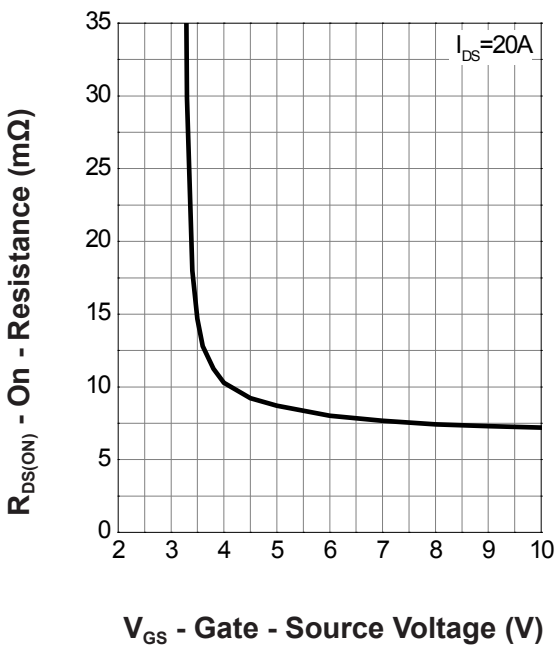
Output Characteristics



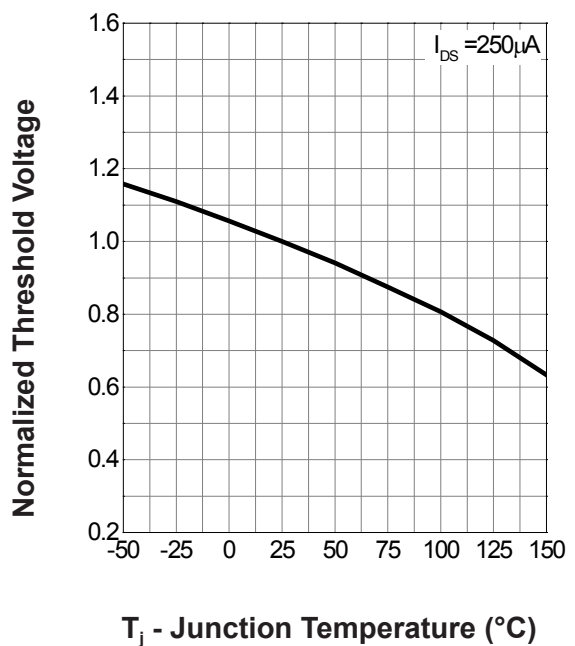
Drain-Source On Resistance



Gate-Source On Resistance

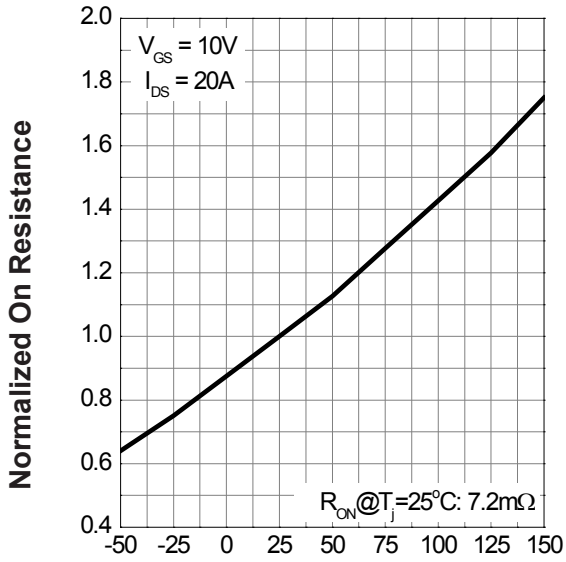


Gate Threshold Voltage



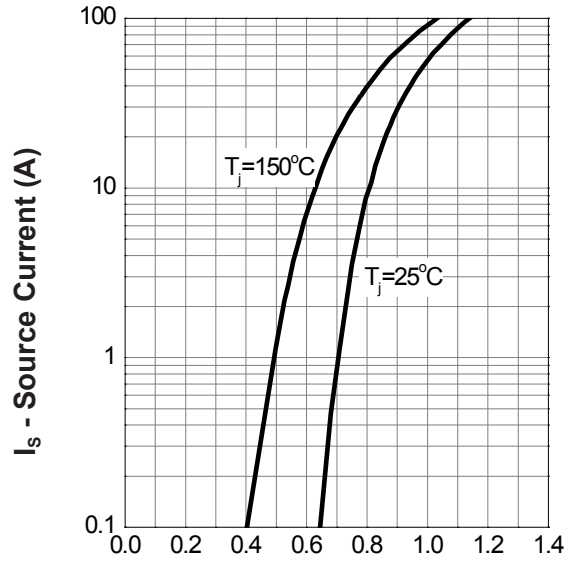
Typical Operating Characteristics(Cont.)

Drain-Source On Resistance



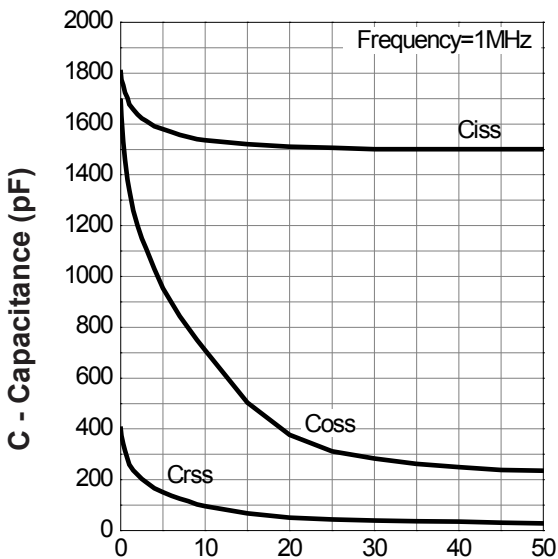
T_j - Junction Temperature (°C)

Source-Drain Diode Forward



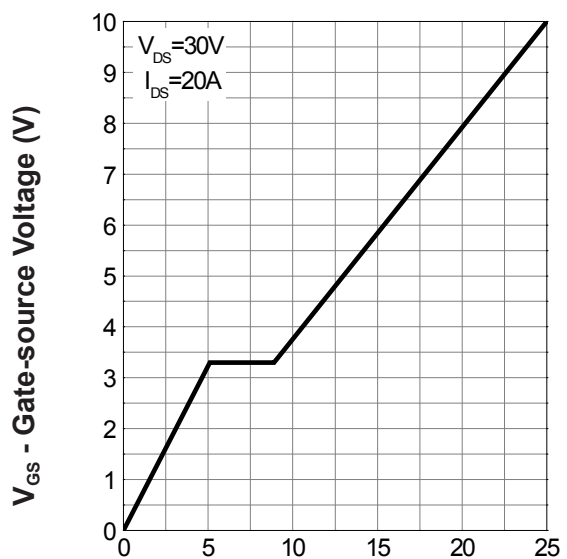
V_{SD} - Source - Drain Voltage (V)

Capacitance



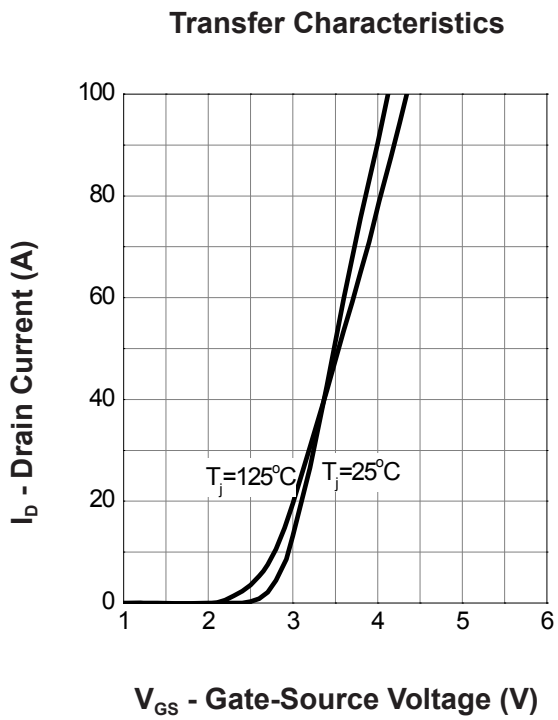
V_{DS} - Drain-Source Voltage (V)

Gate Charge

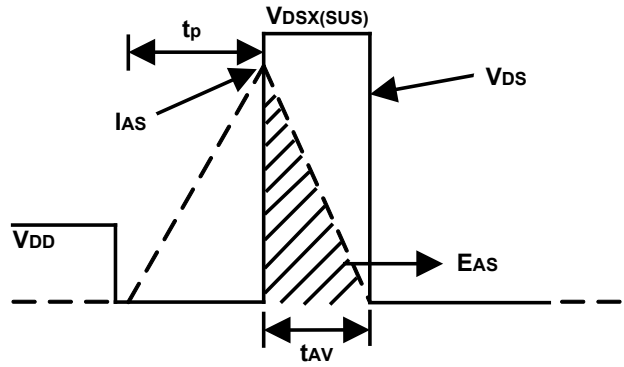
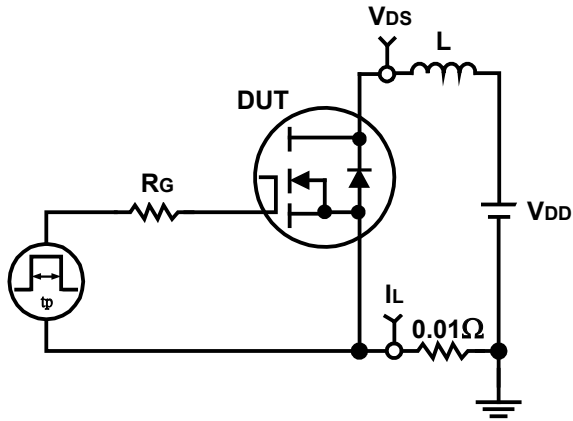


Q_G - Gate Charge (nC)

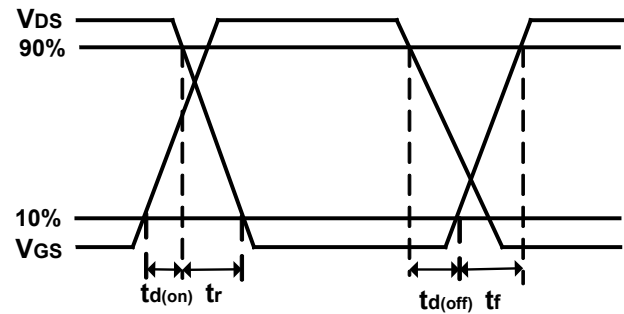
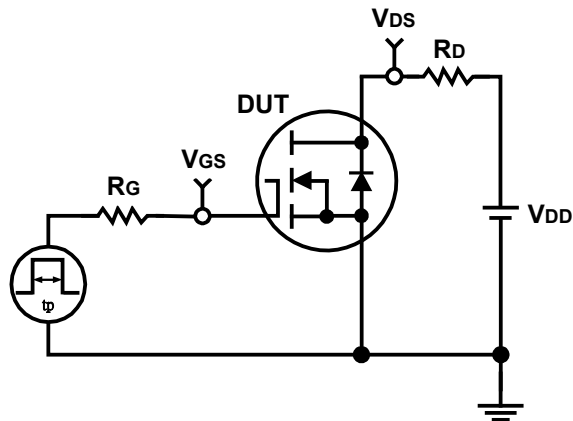
Typical Operating Characteristics(Cont.)



Avalanche Test Circuit and Waveforms



Switching Time Test Circuit and Waveforms



Disclaimer

Sinopower Semiconductor Inc. (hereinafter “Sinopower”) has been making great efforts to development high quality and better performance products to satisfy all customers’ needs. However, a product may fail to meet customer’s expectation or malfunction for various situations.

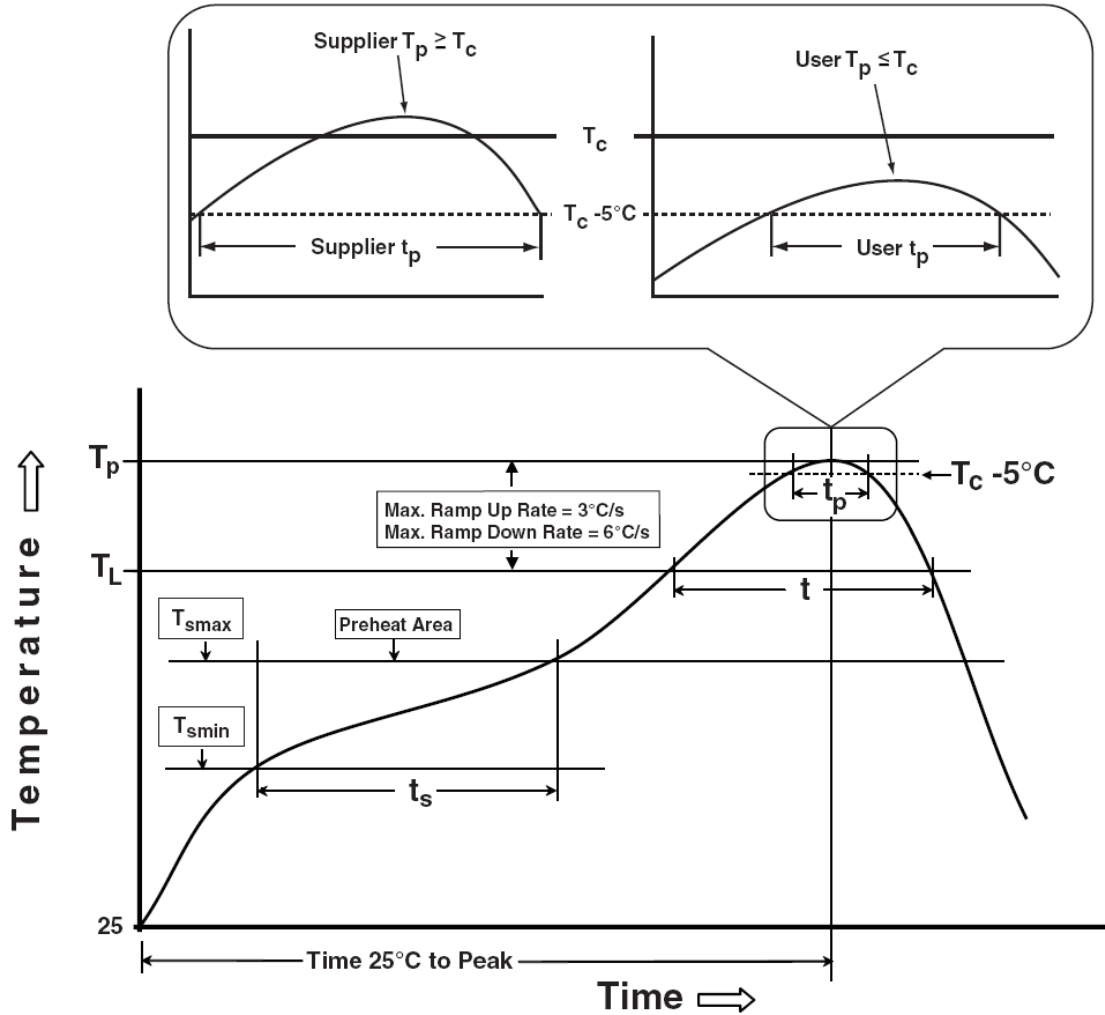
All information which is shown in the datasheet is based on Sinopower’s research and development result, therefore, Sinopower shall reserve the right to adjust the content and monitor the production.

In order to unify the quality and performance, Sinopower has been following JEDEC while defines assembly rule. Notwithstanding all the suppliers basically follow the rule for each product, different processes may cause slightly different results.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the products. Sinopower does not grant customers explicitly or implicitly, any license to use or exercise intellectual property or other rights held by Sinopower and other parties. Sinopower shall bear no responsible whatsoever for any dispute arising from the use of such technical information.

The products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability, such as the failure or malfunction of which any may result in a direct threat to human life or a risk of human injury. Sinopower shall bear no responsibility in any way for use of any of the products for the above special purposes. If a product is intended to use for any such special purpose, such as vehicle, military, or medical controller relevant applications, please contact Sinopower sales representative before purchasing.

Classification Profile



Classification Reflow Profiles

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--|------------------------------------|------------------------------------|
| Preheat & Soak | | |
| Temperature min (T_{smin}) | 100 °C | 150 °C |
| Temperature max (T_{smax}) | 150 °C | 200 °C |
| Time (T_{smin} to T_{smax}) (t_s) | 60-120 seconds | 60-120 seconds |
| Average ramp-up rate (T_{smax} to T_p) | 3 °C/second max. | 3°C/second max. |
| Liquidous temperature (T_L) | 183 °C | 217 °C |
| Time at liquidous (t_L) | 60-150 seconds | 60-150 seconds |
| Peak package body Temperature (T_p)* | See Classification Temp in table 1 | See Classification Temp in table 2 |
| Time (t_p)** within 5°C of the specified classification temperature (T_c) | 20** seconds | 30** seconds |
| Average ramp-down rate (T_p to T_{smax}) | 6 °C/second max. | 6 °C/second max. |
| Time 25°C to peak temperature | 6 minutes max. | 8 minutes max. |
| * Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. | | |
| ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum. | | |

Table 1. SnPb Eutectic Process – Classification Temperatures (T_c)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ ≥350 |
|-------------------|-----------------------------|-----------------------------|
| <2.5 mm | 235 °C | 220 °C |
| ≥2.5 mm | 220 °C | 220 °C |

Table 2. Pb-free Process – Classification Temperatures (T_c)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ 350-2000 | Volume mm ³ >2000 |
|-------------------|-----------------------------|---------------------------------|------------------------------|
| <1.6 mm | 260 °C | 260 °C | 260 °C |
| 1.6 mm – 2.5 mm | 260 °C | 250 °C | 245 °C |
| ≥2.5 mm | 250 °C | 245 °C | 245 °C |

Reliability Test Program

| Test item | Method | Description |
|---------------|---------------|--|
| SOLDERABILITY | JESD-22, B102 | 5 Sec, 245°C |
| HTRB | JESD-22, A108 | 1000 Hrs, 80% of VDS max @ T_{jmax} |
| HTGB | JESD-22, A108 | 1000 Hrs, 100% of VGS max @ T_{jmax} |
| PCT | JESD-22, A102 | 168 Hrs, 100%RH, 2atm, 121°C |
| TCT | JESD-22, A104 | 500 Cycles, -65°C~150°C |

Customer Service

Sinopower Semiconductor Inc.

5F, No. 6, Dusing 1St Rd., Hsinchu Science Park,
Hsinchu, 30078, Taiwan
TEL: 886-3-5635818 Fax: 886-3-5635080